A	2	3	4	5	A
В	R3 46. PGood	4k 23.2k 5 5 5 5 5 6 GND U1 23 FB 6 2 5 6 7 1 1 29 PAD PGOOD 2 6 2 3 27 21 MODE VBST 4 19 VDD SW 6 18 NC V 1	VREG VIN R8 249k 100k PGood PGood C1 0.1µF R11 R11 R9 100k		В
c	J2 2 39357-0002 VIN - 10.8V to 13.2V C13 C13 C18 C14 10μF 10μF 10μF C8 C8 C8 C14 1μF	^{1µF} C15	$ \begin{array}{c} $	VOUT 0.9V@6.5A	c
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